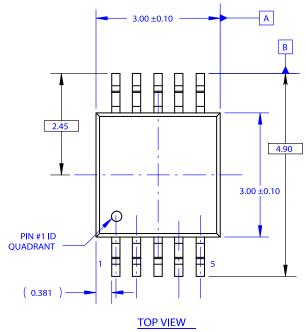
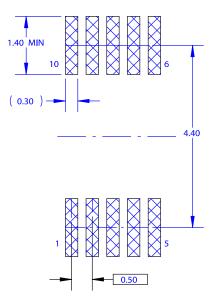


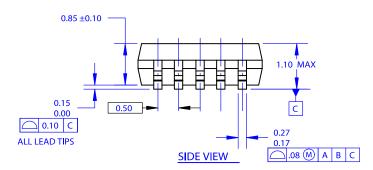


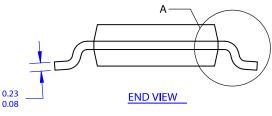
DATE 31 JAN 2017





LAND PATTERN RECOMMENDATION





TOP & BOTTOM GAUGE **PLANE** R 0.13 TYP **SEATING** 4°-8° PI ANE 0.80 0.40 0.22 (0.95)

DETAIL A SCALE 20:1

NOTES: UNLESS OTHERWISE SPECIFIED

- A. THIS PACKAGE CONFORMS TO JEDEC MO-187 VARIATION BA.
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS MOLD FLASH AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES AS PER ASME Y14.5-1994.
- E. LAND PATTERN AS PER IPC7351#SOP50P490X110-10AN

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DESCRIPTION:	MSOP10		PAGE 1 OF 1

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